Low-power configurable gate with voltage-level translator Rev. 01 — 25 October 2007 Product data s

Product data sheet

#### 1. **General description**

The 74AUP1T97 provides low-power, low-voltage configurable logic gate functions. The output state is determined by eight patterns of 3-bit input. The user can choose the logic functions MUX, AND, OR, NAND, NOR, inverter and buffer. All inputs can be connected to V<sub>CC</sub> or GND.

This device ensures a very low static and dynamic power consumption across the entire V<sub>CC</sub> range from 2.3 V to 3.6 V.

The 74AUP1T97 is designed for logic-level translation applications with input switching levels that accept 1.8 V low-voltage CMOS signals, while operating from either a single 2.5 V or 3.3 V supply voltage.

The wide supply voltage range ensures normal operation as battery voltage drops from 3.6 V to 2.3 V.

This device is fully specified for partial power-down applications using I<sub>OFF</sub>. The I<sub>OFF</sub> circuitry disables the output, preventing the damaging backflow current through the device when it is powered down.

Schmitt trigger inputs make the circuit tolerant to slower input rise and fall times across the entire V<sub>CC</sub> range.

#### **Features** 2.

- Wide supply voltage range from 2.3 V to 3.6 V
- High noise immunity
- ESD protection:
  - HBM JESD22-A114E Class 3A exceeds 5000 V
  - MM JESD22-A115-A exceeds 200 V
  - CDM JESD22-C101C exceeds 1000 V
- Low static power consumption;  $I_{CC} = 1.5 \mu A$  (maximum)
- Latch-up performance exceeds 100 mA per JESD 78 Class II
- Inputs accept voltages up to 3.6 V
- Low noise overshoot and undershoot < 10 % of V<sub>CC</sub>
- I<sub>OFF</sub> circuitry provides partial Power-down mode operation
- Multiple package options
- Specified from –40 °C to +85 °C and –40 °C to +125 °C



Low-power configurable gate with voltage-level translator

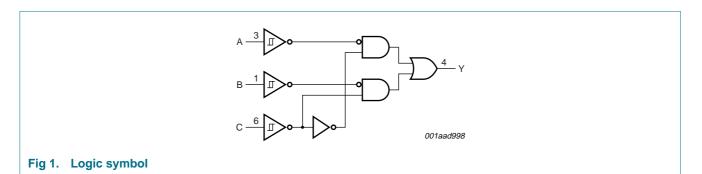
## 3. Ordering information

Table 1. Ordering information										
Type number	Package	Package								
	Temperature range	Name	Description	Version						
74AUP1T97GW	–40 °C to +125 °C	SC-88	plastic surface-mounted package; 6 leads	SOT363						
74AUP1T97GM	–40 °C to +125 °C	XSON6	plastic extremely thin small outline package; no leads; 6 terminals; body 1 $\times$ 1.45 $\times$ 0.5 mm	SOT886						
74AUP1T97GF	–40 °C to +125 °C	XSON6	plastic extremely thin small outline package; no leads; 6 terminals; body 1 $\times$ 1 $\times$ 0.5 mm	SOT891						

## 4. Marking

Table 2. Marking	
Type number	Marking code
74AUP1T97GW	59
74AUP1T97GM	59
74AUP1T97GF	59

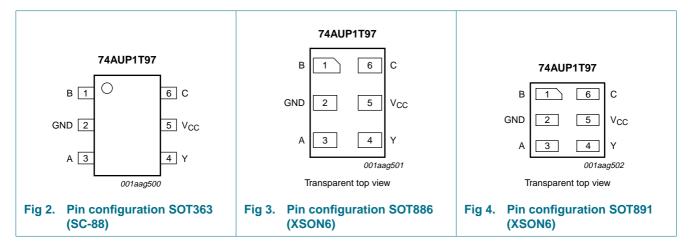
# 5. Functional diagram



Low-power configurable gate with voltage-level translator

## 6. Pinning information

## 6.1 Pinning



## 6.2 Pin description

Table 3.	Pin description	
Symbol	Pin	Description
В	1	data input
GND	2	ground (0 V)
А	3	data input
Y	4	data output
V <sub>CC</sub>	5	supply voltage
С	6	data input

## 7. Functional description

#### Table 4. Function table<sup>[1]</sup> Input Output С в Υ Α L L L L L L L Н Н L Н L L Н Н Н Н L L L Н Н L Н L Н Н L Н Н Н Н

[1] H = HIGH voltage level;

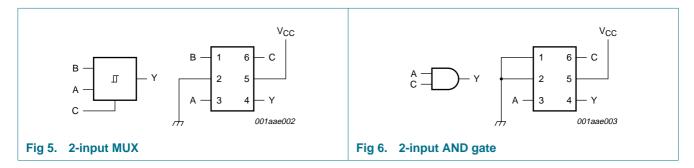
L = LOW voltage level.

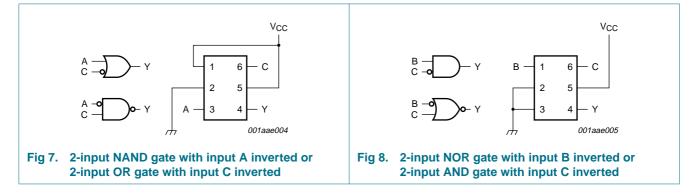
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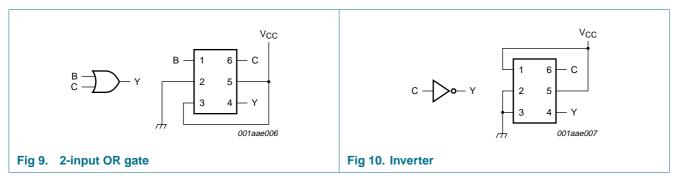
## 7.1 Logic configurations

### Table 5. Function selection table

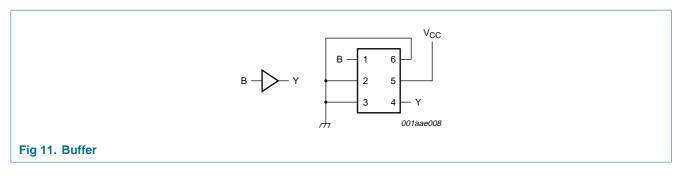
Logic function	Figure
2-input MUX	see Figure 5
2-input AND	see Figure 6
2-input OR with one input inverted	see Figure 7
2-input NAND with one input inverted	see Figure 7
2-input AND with one input inverted	see Figure 8
2-input NOR with one input inverted	see Figure 8
2-input OR	see Figure 9
Inverter	see Figure 10
Buffer	see Figure 11







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## 8. Limiting values

### Table 6.Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134). Voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions	Min	Мах	Unit
V <sub>CC</sub>	supply voltage		-0.5	+4.6	V
I <sub>IK</sub>	input clamping current	V <sub>1</sub> < 0 V	-50	-	mA
VI	input voltage		<u>[1]</u> –0.5	+4.6	V
I <sub>OK</sub>	output clamping current	$V_{\rm O}$ > $V_{\rm CC}$ or $V_{\rm O}$ < 0 V	-50	-	mA
Vo	output voltage	Active mode and Power-down mode	<u>[1]</u> –0.5	+4.6	V
lo	output current	$V_{O} = 0 V$ to $V_{CC}$	-	±20	mA
I <sub>CC</sub>	supply current		-	50	mA
I <sub>GND</sub>	ground current		-50	-	mA
T <sub>stg</sub>	storage temperature		-65	+150	°C
P <sub>tot</sub>	total power dissipation	$T_{amb} = -40 \ ^{\circ}C$ to +125 $^{\circ}C$	[2] _	250	mW

[1] The minimum input and output voltage ratings may be exceeded if the input and output current ratings are observed.

## 9. Recommended operating conditions

### Table 7. Recommended operating conditions

Symbol	Parameter	Conditions	Min	Max	Unit
V <sub>CC</sub>	supply voltage		2.3	3.6	V
VI	input voltage		0	3.6	V
Vo	output voltage	Active mode	0	V <sub>CC</sub>	V
		Power-down mode; $V_{CC} = 0 V$	0	3.6	V
T <sub>amb</sub>	ambient temperature		-40	+125	°C

## Low-power configurable gate with voltage-level translator

## **10. Static characteristics**

### Table 8. Static characteristics

At recommended operating conditions; voltages are referenced to GND (ground = 0 V).

-	Parameter	Conditions	Min	Тур	Max	Unit
T <sub>amb</sub> = 2	25 °C					
V <sub>T+</sub>	positive-going threshold	$V_{CC}$ = 2.3 V to 2.7 V	0.60	-	1.10	V
	voltage	$V_{CC}$ = 3.0 V to 3.6 V	0.75	-	1.16	V
V <sub>T-</sub>	negative-going threshold	$V_{CC}$ = 2.3 V to 2.7 V	0.35	-	0.60	V
	voltage	$V_{CC} = 3.0 \text{ V} \text{ to } 3.6 \text{ V}$	0.50	-	0.85	V
V <sub>H</sub>	hysteresis voltage	$(V_H=V_{T+}-V_{T-})$				
		$V_{CC} = 2.3 \text{ V} \text{ to } 2.7 \text{ V}$	0.23	-	0.60	V
		$V_{CC} = 3.0 \text{ V} \text{ to } 3.6 \text{ V}$	0.25	-	0.56	V
V <sub>ОН</sub>	HIGH-level output voltage	$V_I = V_{IH} \text{ or } V_{IL}$				
		$I_{O}$ = –20 $\mu\text{A};V_{CC}$ = 2.3 V to 3.6 V	$V_{CC} - 0.1$	-	-	V
		$I_{O} = -2.3 \text{ mA}; V_{CC} = 2.3 \text{ V}$	2.05	-	-	V
		$I_{O} = -3.1 \text{ mA}; V_{CC} = 2.3 \text{ V}$	1.9	-	-	V
		$I_{O} = -2.7$ mA; $V_{CC} = 3.0$ V	2.72	-	-	V
		$I_{O} = -4.0 \text{ mA}; V_{CC} = 3.0 \text{ V}$	2.6	-	-	V
V <sub>OL</sub>	LOW-level output voltage	$V_I = V_{IH} \text{ or } V_{IL}$				
		$I_{O}$ = 20 $\mu$ A; $V_{CC}$ = 2.3 V to 3.6 V	-	-	0.10	V
		$I_0 = 2.3 \text{ mA}; V_{CC} = 2.3 \text{ V}$	-	-	0.31	V
		$I_0 = 3.1 \text{ mA}; V_{CC} = 2.3 \text{ V}$	-	-	0.44	V
		$I_0 = 2.7 \text{ mA}; V_{CC} = 3.0 \text{ V}$	-	-	0.31	V
		$I_0 = 4.0 \text{ mA}; V_{CC} = 3.0 \text{ V}$	-	-	0.44	V
I	input leakage current	$V_I = GND$ to 3.6 V; $V_{CC} = 0$ V to 3.6 V	-	-	±0.1	μA
I <sub>OFF</sub>	power-off leakage current	$V_1$ or $V_0 = 0$ V to 3.6 V; $V_{CC} = 0$ V	-	-	±0.1	μA
$\Delta I_{OFF}$	additional power-off leakage current	$V_1 \text{ or } V_0 = 0 \text{ V to } 3.6 \text{ V};$ $V_{CC} = 0 \text{ V to } 0.2 \text{ V}$	-	-	±0.2	μA
l <sub>cc</sub>	supply current	$V_{I} = GND \text{ or } V_{CC}; I_{O} = 0 \text{ A};$ $V_{CC} = 2.3 \text{ V to } 3.6 \text{ V}$	-	-	1.2	μA
Cı	input capacitance	$V_{CC} = 0$ V to 3.6 V; $V_{I} = GND$ or $V_{CC}$	-	0.8	-	pF
Co	output capacitance	$V_O = GND; V_{CC} = 0 V$	-	1.7	-	pF
T <sub>amb</sub> = -	40 °C to +85 °C					
V <sub>T+</sub>	positive-going threshold	$V_{CC} = 2.3 \text{ V} \text{ to } 2.7 \text{ V}$	0.60	-	1.10	V
	voltage	$V_{CC} = 3.0 \text{ V} \text{ to } 3.6 \text{ V}$	0.75	-	1.19	V
V <sub>T-</sub>	negative-going threshold	$V_{CC} = 2.3 \text{ V to } 2.7 \text{ V}$	0.35	-	0.60	V
	voltage	V <sub>CC</sub> = 3.0 V to 3.6 V	0.50	-	0.85	V
V <sub>H</sub>	hysteresis voltage	$(V_{H} = V_{T+} - V_{T-})$				
	. 0	$V_{CC} = 2.3 \text{ V to } 2.7 \text{ V}$	0.10	-	0.60	V
		$V_{CC} = 3.0 \text{ V to } 3.6 \text{ V}$	0.15		0.56	V

## **NXP Semiconductors**

# 74AUP1T97

## Low-power configurable gate with voltage-level translator

### Table 8. Static characteristics ...continued

At recommended operating conditions; voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
V <sub>он</sub>	HIGH-level output voltage	$V_{I} = V_{IH} \text{ or } V_{IL}$				
		$I_{O}$ = –20 $\mu\text{A};V_{CC}$ = 2.3 V to 3.6 V	$V_{CC} - 0.1$	-	-	V
		$I_{O} = -2.3 \text{ mA}; V_{CC} = 2.3 \text{ V}$	1.97	-	-	V
		$I_0 = -3.1 \text{ mA}; V_{CC} = 2.3 \text{ V}$	1.85	-	-	V
		$I_0 = -2.7 \text{ mA}; V_{CC} = 3.0 \text{ V}$	2.67	-	-	V
		$I_{O} = -4.0 \text{ mA}; V_{CC} = 3.0 \text{ V}$	2.55	-	-	V
V <sub>OL</sub>	LOW-level output voltage	$V_{I} = V_{IH} \text{ or } V_{IL}$				
		$I_{O}$ = 20 $\mu$ A; $V_{CC}$ = 2.3 V to 3.6 V	-	-	0.1	V
		$I_0 = 2.3 \text{ mA}; V_{CC} = 2.3 \text{ V}$	-	-	0.33	V
		$I_0 = 3.1 \text{ mA}; V_{CC} = 2.3 \text{ V}$	-	-	0.45	V
		$I_0 = 2.7 \text{ mA}; V_{CC} = 3.0 \text{ V}$	-	-	0.33	V
		$I_0 = 4.0 \text{ mA}; V_{CC} = 3.0 \text{ V}$	-	-	0.45	V
l	input leakage current	$V_I = GND$ to 3.6 V; $V_{CC} = 0$ V to 3.6 V	-	-	±0.5	μA
OFF	power-off leakage current	$V_1$ or $V_0 = 0$ V to 3.6 V; $V_{CC} = 0$ V	-	-	±0.5	μA
∆I <sub>OFF</sub>	additional power-off leakage current	$V_1$ or $V_0 = 0$ V to 3.6 V; $V_{CC} = 0$ V to 0.2 V	-	-	±0.5	μΑ
lcc	supply current	$V_{I} = GND \text{ or } V_{CC}; I_{O} = 0 \text{ A};$ $V_{CC} = 2.3 \text{ V to } 3.6 \text{ V}$	-	-	1.5	μA
۵lcc	additional supply current	$V_{CC}$ = 2.3 V to 2.7 V; $I_O$ = 0 A	<u>[1]</u> _	-	4	μA
		$V_{CC}$ = 3.0 V to 3.6 V; $I_{O}$ = 0 A	[2] _	-	12	μA
T <sub>amb</sub> = -4	40 °C to +125 °C					
V <sub>T+</sub>	positive-going threshold	$V_{CC}$ = 2.3 V to 2.7 V	0.60	-	1.10	V
	voltage	$V_{CC} = 3.0 \text{ V} \text{ to } 3.6 \text{ V}$	0.75	-	1.19	V
V <sub>T-</sub>	negative-going threshold	$V_{CC}$ = 2.3 V to 2.7 V	0.33	-	0.64	V
	voltage	$V_{CC} = 3.0 \text{ V} \text{ to } 3.6 \text{ V}$	0.46	-	0.85	V
V <sub>H</sub>	hysteresis voltage	$(V_H = V_T+ - V_T-)$				
		$V_{CC}$ = 2.3 V to 2.7 V	0.10	-	0.60	V
		$V_{CC} = 3.0 V \text{ to } 3.6 V$	0.15	-	0.56	V
V <sub>он</sub>	HIGH-level output voltage	$V_{I} = V_{IH} \text{ or } V_{IL}$				
		$I_{O}$ = -20 $\mu$ A; V <sub>CC</sub> = 2.3 V to 3.6 V	V <sub>CC</sub> – 0.11	-	-	V
		$I_{O} = -2.3 \text{ mA}; V_{CC} = 2.3 \text{ V}$	1.77	-	-	V
		$I_{O} = -3.1 \text{ mA}; V_{CC} = 2.3 \text{ V}$	1.67	-	-	V
		$I_{O} = -2.7 \text{ mA}; V_{CC} = 3.0 \text{ V}$	2.40	-	-	V
		$I_{O} = -4.0 \text{ mA}; V_{CC} = 3.0 \text{ V}$	2.30	-	-	V
V <sub>OL</sub>	LOW-level output voltage	$V_{I} = V_{IH}$ or $V_{IL}$				
		$I_0 = 20 \ \mu$ A; $V_{CC} = 2.3 \ V$ to 3.6 V	-	-	0.11	V
		$I_0 = 2.3 \text{ mA}; V_{CC} = 2.3 \text{ V}$	-	-	0.36	V
		$I_0 = 3.1 \text{ mA}; V_{CC} = 2.3 \text{ V}$	-	-	0.50	V
		$I_0 = 2.7 \text{ mA}; V_{CC} = 3.0 \text{ V}$	-	-	0.36	V
		$I_0 = 4.0 \text{ mA}; V_{CC} = 3.0 \text{ V}$	-	-	0.50	V

### Low-power configurable gate with voltage-level translator

At recommended operating conditions; voltages are referenced to $GND$ (ground = 0 V).								
Symbol	Parameter	Conditions	Min	Тур	Max	Unit		
I <sub>OFF</sub>	power-off leakage current	$V_1 \text{ or } V_0 = 0 \text{ V to } 3.6 \text{ V}; V_{CC} = 0 \text{ V}$	-	-	±0.75	μΑ		
$\Delta I_{OFF}$	additional power-off leakage current	$V_1$ or $V_0 = 0$ V to 3.6 V; $V_{CC} = 0$ V to 0.2 V	-	-	±0.75	μA		
I <sub>CC</sub>	supply current	$\label{eq:VI} \begin{array}{l} V_{I} = GND \text{ or } V_{CC}; \ I_{O} = 0 \ A; \\ V_{CC} = 2.3 \ V \ \text{to} \ 3.6 \ V \end{array}$	-	-	3.5	μA		
$\Delta I_{CC}$	additional supply current	$V_{CC}$ = 2.3 V to 2.7 V; $I_{O}$ = 0 A	<u>[1]</u> _	-	7	μA		
		$V_{CC}$ = 3.0 V to 3.6 V; $I_O$ = 0 A	[2] _	-	22	μA		

#### Table 8. Static characteristics ... continued

[1] One input at 0.3 V or 1.1 V, other input at  $V_{CC}$  or GND.

[2] One input at 0.45 V or 1.2 V, other input at V<sub>CC</sub> or GND.

## 11. Dynamic characteristics

#### **Dynamic characteristics** Table 9.

Voltages are referenced to GND (ground = 0 V); for test circuit see Figure 13.

Symbol	Parameter	Conditions		25 °C		–40 °C to +125 °C			Unit	
				Min	Typ <mark>[1]</mark>	Мах	Min	Max (85 °C)	Max (125 °C)	
V <sub>CC</sub> = 2.	3 V to 2.7 V; V <sub>I</sub> = 1.6	65 V to 1.95 V								
t <sub>pd</sub>	propagation delay	A, B, C to Y; see Figure 12	[2]							
		C <sub>L</sub> = 5 pF		2.2	3.5	5.5	0.5	6.8	7.5	ns
		C <sub>L</sub> = 10 pF		2.6	4.1	6.3	1.0	7.9	8.7	ns
		C <sub>L</sub> = 15 pF		2.9	4.6	6.9	1.0	8.7	9.6	ns
		C <sub>L</sub> = 30 pF		3.7	5.8	8.4	1.5	10.8	11.9	ns
V <sub>CC</sub> = 2.	3 V to 2.7 V; V <sub>I</sub> = 2.3	3 V to 2.7 V								
t <sub>pd</sub>	propagation delay	A, B, C to Y; see Figure 12	[2]							
		C <sub>L</sub> = 5 pF		1.8	3.4	5.5	0.5	6.0	6.6	ns
		C <sub>L</sub> = 10 pF		2.2	4.0	6.2	1.0	7.1	7.9	ns
		C <sub>L</sub> = 15 pF		2.5	4.4	6.8	1.0	7.9	8.7	ns
		C <sub>L</sub> = 30 pF		3.2	5.6	8.3	1.5	10.0	11.0	ns
V <sub>CC</sub> = 2.	3 V to 2.7 V; V <sub>I</sub> = 3.0	) V to 3.6 V								
t <sub>pd</sub>	propagation delay	A, B, C to Y; see Figure 12	[2]							
		C <sub>L</sub> = 5 pF		1.4	3.1	5.0	0.5	5.5	6.1	ns
		C <sub>L</sub> = 10 pF		1.8	3.7	5.7	1.0	6.5	7.2	ns
		C <sub>L</sub> = 15 pF		2.2	4.2	6.3	1.0	7.4	8.2	ns
		C <sub>L</sub> = 30 pF		2.9	5.3	7.9	1.5	9.5	10.5	ns
V <sub>CC</sub> = 3.	0 V to 3.6 V; V <sub>I</sub> = 1.6	65 V to 1.95 V								
t <sub>pd</sub>	propagation delay	A, B, C to Y; see Figure 12	[2]							
		C <sub>L</sub> = 5 pF		2.1	2.9	3.9	0.5	8.0	8.8	ns
		C <sub>L</sub> = 10 pF		2.5	3.4	4.6	1.0	8.5	9.4	ns
		C <sub>L</sub> = 15 pF		2.9	3.9	5.2	1.0	9.1	10.1	ns
		C <sub>L</sub> = 30 pF		3.6	5.0	6.7	1.5	9.8	10.8	ns

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### Low-power configurable gate with voltage-level translator

Symbol	Parameter	Conditions		25 °C		-4	0 °C to +1	25 °C	Unit
				Typ[1]	Max	Min	Max (85 °C)	Max (125 °C)	
V <sub>CC</sub> = 3.	0 V to 3.6 V; V <sub>I</sub> = 2.3	3 V to 2.7 V							
t <sub>pd</sub>	propagation delay	A, B, C to Y; see Figure 12 [2]							
		C <sub>L</sub> = 5 pF	1.7	2.8	4.2	0.5	5.3	5.9	ns
		C <sub>L</sub> = 10 pF	2.1	3.4	5.0	1.0	6.1	6.8	ns
		C <sub>L</sub> = 15 pF	2.4	3.8	5.6	1.0	6.8	7.5	ns
		C <sub>L</sub> = 30 pF	3.2	5.0	7.1	1.5	8.5	9.4	ns
V <sub>CC</sub> = 3.	0 V to 3.6 V; V <sub>I</sub> = 3.0	) V to 3.6 V							
t <sub>pd</sub>	propagation delay	A, B, C to Y; see Figure 12 [2]							
		C <sub>L</sub> = 5 pF	1.4	2.7	4.2	0.5	4.7	5.2	ns
		C <sub>L</sub> = 10 pF	1.8	3.3	5.0	1.0	5.7	6.3	ns
		C <sub>L</sub> = 15 pF	2.1	3.8	5.6	1.0	6.2	6.9	ns
		C <sub>L</sub> = 30 pF	2.9	4.9	7.1	1.5	7.8	8.6	ns
T <sub>amb</sub> = 2	25 °C								
C <sub>PD</sub>	power dissipation	$f_i = 1 \text{ MHz}; V_I = \text{GND to } V_{\text{CC}}$ [3]							
	capacitance	$V_{CC}$ = 2.3 V to 2.7 V	-	3.6	-	-	-	-	pF
		$V_{CC} = 3.0 \text{ V} \text{ to } 3.6 \text{ V}$	-	4.3	-	-	-	-	pF

#### Table 9. Dynamic characteristics ... continued

[1] All typical values are measured at nominal V<sub>CC</sub>.

[2]  $t_{pd}$  is the same as  $t_{PLH}$  and  $t_{PHL}$ 

[3]  $C_{PD}$  is used to determine the dynamic power dissipation (P<sub>D</sub> in  $\mu$ W).

 $P_{D} = C_{PD} \times V_{CC}^{2} \times f_{i} \times N + \Sigma (C_{L} \times V_{CC}^{2} \times f_{o}) \text{ where:}$ 

 $f_i$  = input frequency in MHz;

 $f_0$  = output frequency in MHz;

 $C_{L}$  = output load capacitance in pF;

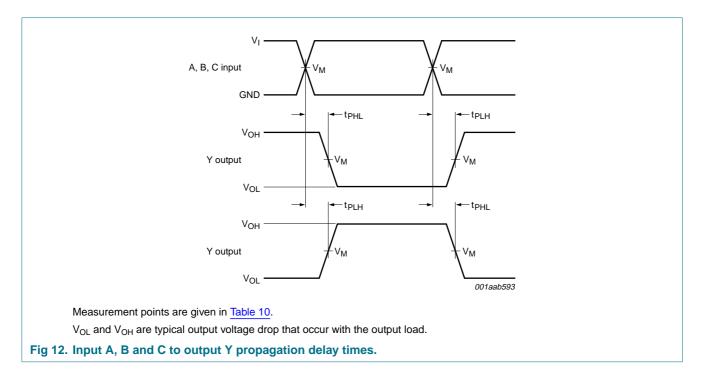
 $V_{CC}$  = supply voltage in V;

N = number of inputs switching;

 $\Sigma(C_L \times V_{CC}^2 \times f_o)$  = sum of the outputs.

Low-power configurable gate with voltage-level translator

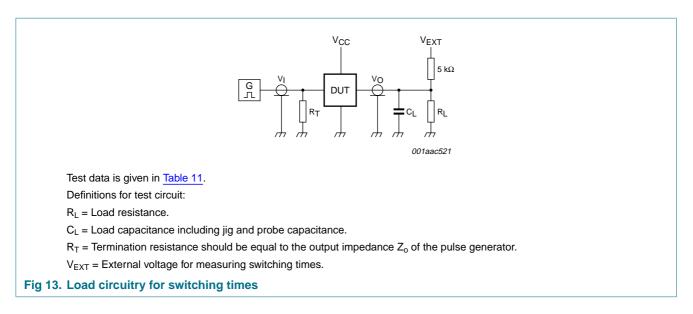
## 12. Waveforms



### Table 10. Measurement points

Supply voltage	Output	Input					
V <sub>CC</sub>	V <sub>M</sub>	V <sub>M</sub>	VI	t <sub>r</sub> = t <sub>f</sub>			
2.3 V to 3.6 V	0.5V <sub>CC</sub>	0.5V <sub>I</sub>	1.65 V to 3.6 V	≤ 3.0 ns			

### Low-power configurable gate with voltage-level translator



### Table 11. Test data

Supply voltage	Load		V <sub>EXT</sub>		
V <sub>cc</sub>	CL	R <sub>L</sub> [1]	t <sub>PLH</sub> , t <sub>PHL</sub>	t <sub>PZH</sub> , t <sub>PHZ</sub>	t <sub>PZL</sub> , t <sub>PLZ</sub>
2.3 V to 3.6 V	5 pF, 10 pF, 15 pF and 30 pF	5 k $\Omega$ or 1 M $\Omega$	open	GND	$2 \times V_{CC}$

[1] For measuring enable and disable times  $R_L = 5 k\Omega$ , for measuring propagation delays, setup and hold times and pulse width  $R_L = 1 M\Omega$ .

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## 13. Package outline

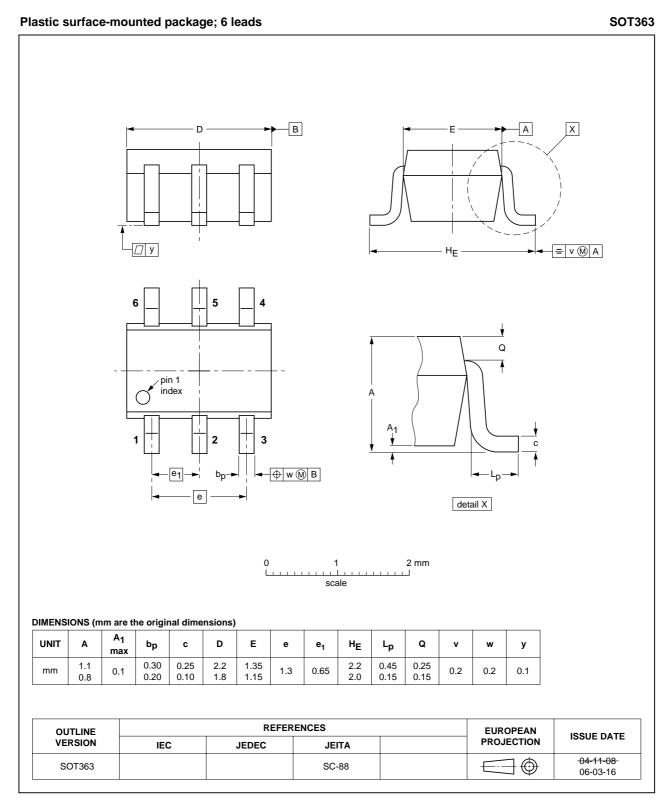
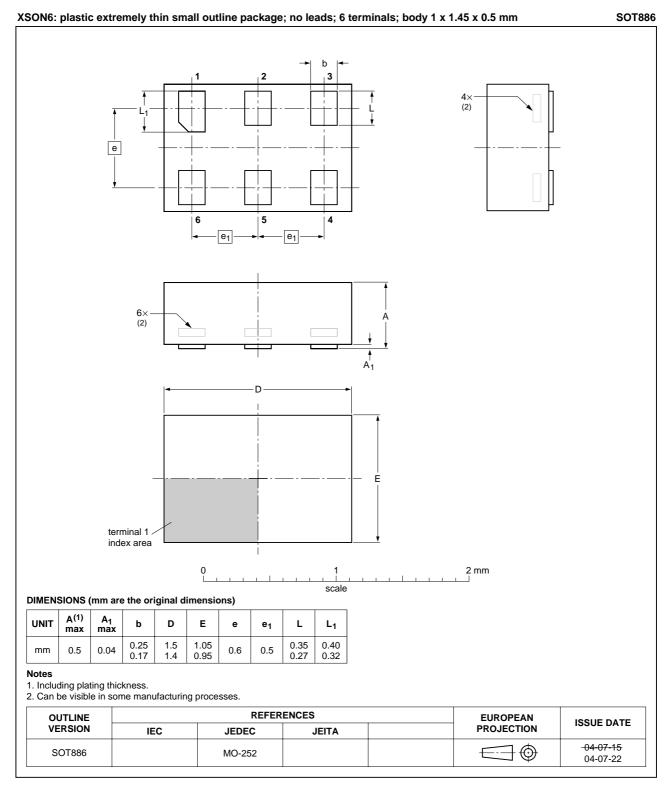


Fig 14. Package outline SOT363 (SC-88)

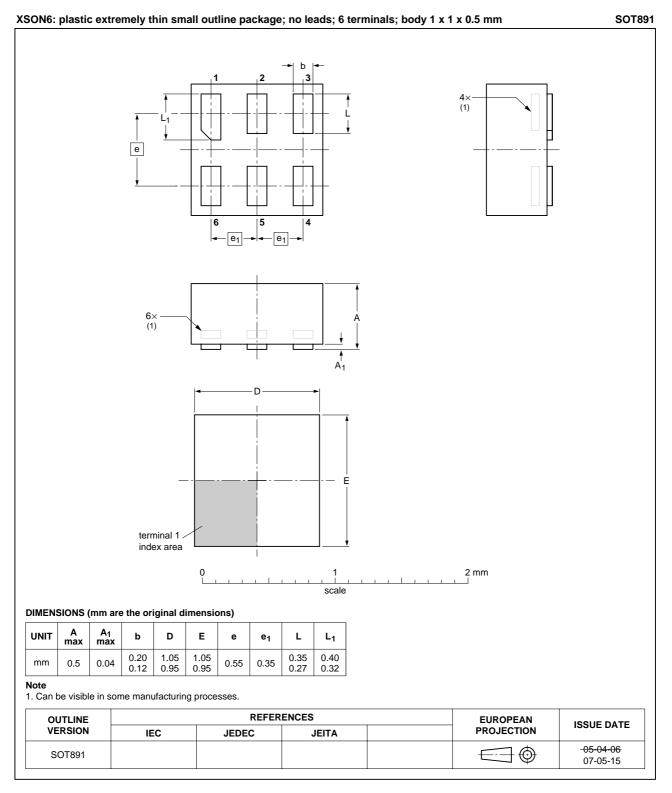
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### Fig 15. Package outline SOT886 (XSON6)

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### Fig 16. Package outline SOT891 (XSON6)

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## 14. Abbreviations

Table 12.	Abbreviations	
Acronym	Description	
CDM	Charged Device Model	
CMOS	Complementary Metal Oxide Semiconductor	
DUT	Device Under Test	
ESD	ElectroStatic Discharge	
HBM	Human Body Model	
MM	Machine Model	
TTL	Transistor-Transistor Logic	

# **15. Revision history**

Table 13. Revision history				
Document ID	Release date	Data sheet status	Change notice	Supersedes
74AUP1T97_1	20071025	Product data sheet	-	-

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## **16. Legal information**

## 16.1 Data sheet status

Document status <sup>[1][2]</sup>	Product status <sup>[3]</sup>	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

[1] Please consult the most recently issued document before initiating or completing a design.

[2] The term 'short data sheet' is explained in section "Definitions".

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